

STL140N4LLF5

N-channel 40 V, 2.2 mΩ typ., 32 A STripFET™ F5 Power MOSFET in a PowerFLAT™ 5x6 package

Datasheet - production data

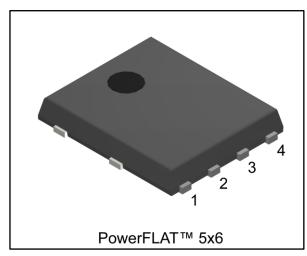
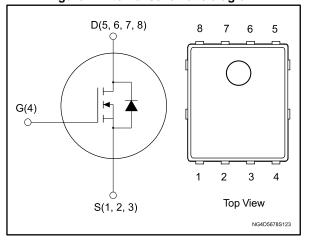


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STL140N4LLF5	40 V	2.75 mΩ	32 A

- Low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power loss

Applications

Switching applications

Description

This N-channel Power MOSFET is developed using the STripFET™ F5 technology and has been optimized to achieve very low on-state resistance, contributing to a FoM that is among the best in its class.

Table 1: Device summary

Order code	Marking	Package	Packing
STL140N4LLF5	140N4LF5	PowerFLAT™ 5x6	Tape and reel

Contents STL140N4LLF5

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STL140N4LLF5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	40	V
V_{GS}	Gate-source voltage	±22	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	140	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	88	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 25 °C	32	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 100 °C	20	Α
I _{DM} ⁽³⁾	Drain current (pulsed)	128	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	80	W
P _{TOT} ⁽²⁾	Total dissipation at T _{pcb} = 25 °C	4	W
T _{stg}	Storage temperature range	-55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.56	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb		°C/W

Notes:

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lav	Not-repetitive avalanche current, (pulse width limited by T _{jmax})	16	Α
Eas	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$, $V_{DD} = 24$ V)	300	mJ

 $[\]ensuremath{^{(1)}}\xspace$ This value is rated according to $R_{thj\text{-case}.}$

 $[\]ensuremath{^{(2)}}\xspace$ This value is rated according to $R_{thj\text{-pcb.}}$

⁽³⁾Pulse width limited by safe operating area.

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2 oz Cu t <10 sec

Electrical characteristics STL140N4LLF5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	40			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V},$ $T_{C} = 125 \text{ °C} \text{ (1)}$			10	μΑ
lgss	Gate body leakage current	V _{DS} = 0 V, V _{GS} = ±22 V			±100	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1			V
Static drain-source	Static drain-source	V _{GS} = 10 V, I _D = 16 A		2.2	2.75	mΩ
KDS(on)	R _{DS(on)} on-resistance	V _{GS} = 4.5 V, I _D = 16 A		2.4	3.1	mΩ

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	5900		pF
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz},$	-	870	•	pF
Crss	Reverse transfer capacitance	Ves = 0 V	-	130		pF
Qg	Total gate charge	V _{DD} = 15 V, I _D = 32 A	-	45	•	nC
Q_{gs}	Gate-source charge	V _{GS} = 0 to 4.5 V,		14		nC
Q _{gd}	Gate-drain charge	see (Figure 14: "Test circuit for gate charge behavior")	-	17	1	nC
R _G	Gate input resistance	f=1 MHz, gate DC bias = 0 V, test signal level = 20 mV, I _D = 0 A	-	1.2	-	Ω

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 15 V, I_D = 16 A,	-	19	-	ns
tr	Rise time	$R_G = 4.7 \Omega$	ı	29	1	ns
$t_{d(off)}$	Turn-off delay time	V _{GS} = 10 V, (see Figure 13: "Test circuit for	1	90	-	ns
t _f	Fall time	resistive load switching times" and Figure 18: "Switching time waveform")	-	21	-	ns

 $^{^{(1)}}$ Defined by design, not subject to production test.

Table 8: Source-drain diode

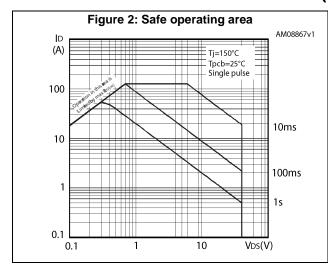
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isp	Forward on voltage		-		32	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		128	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 32 A, V _{GS} =0 V	-		1.1	V
t _{rr}	Reverse recovery time	Reverse recovery time $I_{SD} = 32 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$		44		ns
Qrr	Reverse recovery charge	V _{DD} = 25 V (see Figure 15: "Test circuit for	-	57		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	2.6		Α

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration=300µs, duty cycle 1.5%.

2.1 Electrical characteristics (curves)



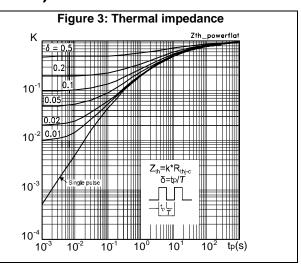
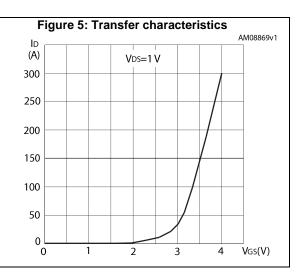
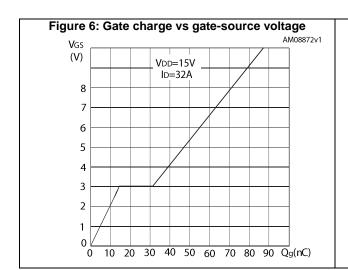
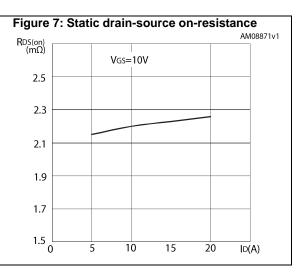


Figure 4: Output characteristics AM08868v1 ID (A) 4٧ 350 VGS=10V 300 250 200 150 100 50 3V 2V 0.5 V_Ds(V) 1.0 1.5







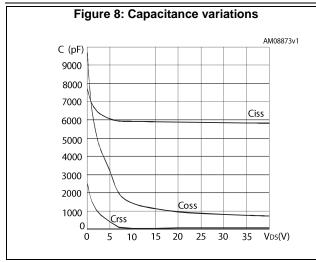
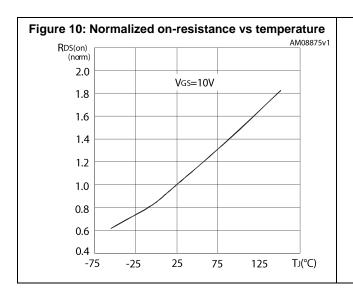
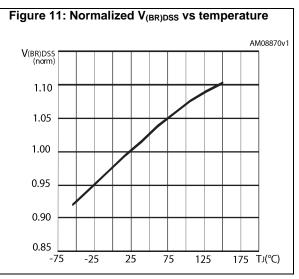
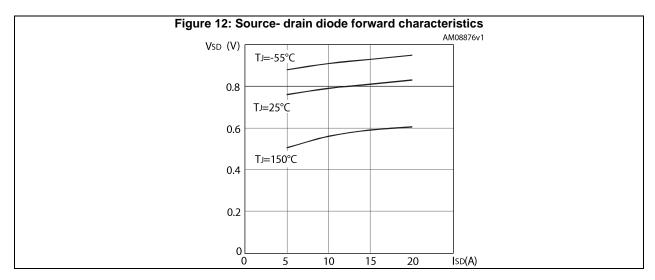


Figure 9: Normalized gate threshold voltage vs temperature AM08874v1 VGS(th) (norm) 1.2 1.0 0.8 0.6 0.4 0.2 -75 -25 25 75 125 175 TJ(°C)

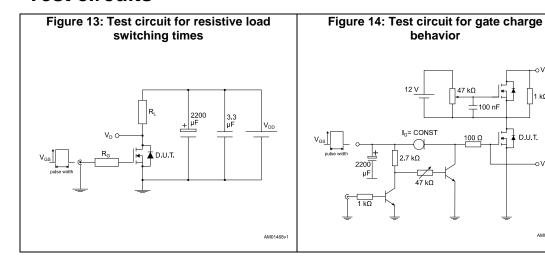


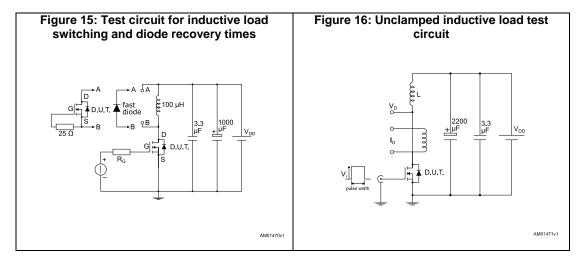


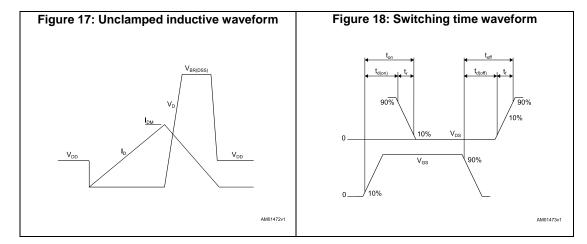


Test circuits STL140N4LLF5

3 **Test circuits**







1 kΩ

⊥ 100 nF

Package information 4

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

PowerFLAT™ 5x6 type C package information 4.1

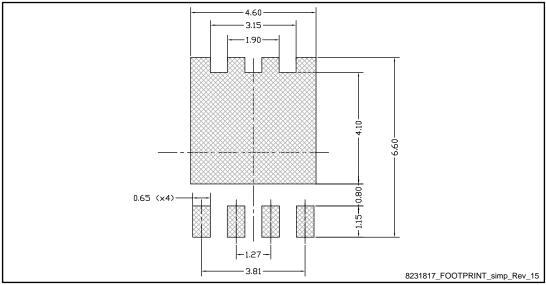
6 7 8 E_{7} E2 E3 Bottom view D5(x4) b(x8) e(x6) Side view Top view 8231817_typeC_A0ER_Rev15

Figure 19: PowerFLAT™ 5x6 type C package outline

Table 9: PowerFLAT™ 5x6 type C package mechanical data

	Oxoty		
Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.20
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.20
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
е		1.27	
Е	5.95	6.15	6.35
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.75	0.90	1.05
K	1.05		1.35
L	0.725		1.025
L1	0.05	0.15	0.25
θ	0°		12°

Figure 20: PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)



STL140N4LLF5 Package information

4.2 PowerFLAT™ 5x6 packing information

Figure 21: PowerFLAT™ 5x6 tape (dimensions are in mm)

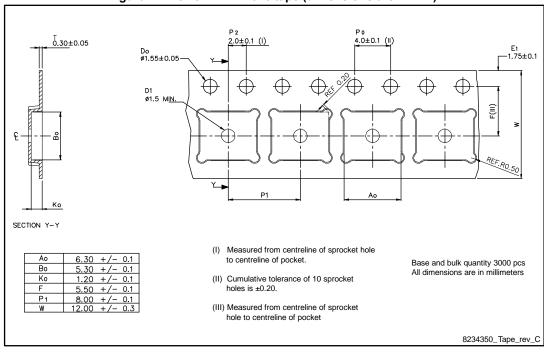


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape

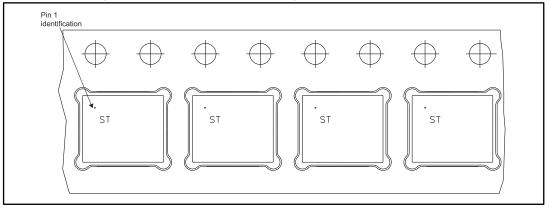


Figure 23: PowerFLAT™ 5x6 reel

PART NO.

R25.00

R25.00

R25.00

R25.00

R25.00

R25.00

R330 (+0/-4.0)

R1.10

R21.10

R21.20

R21.20

R22.20

All dimensions are in millimeters

CORE DETAIL

8234350_Reel_rev_C

STL140N4LLF5 Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
03-Jun-2010	1	First release.
29-Apr-2011	2	Document status promoted from preliminary data to datasheet.
10-Nov-2011	3	Section 4: Package mechanical data has been updated. Minor text changes.
08-Aug-2017 4		Modified Table 1: "Device summary". Updated Section 5: "Package information". Minor text changes.

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